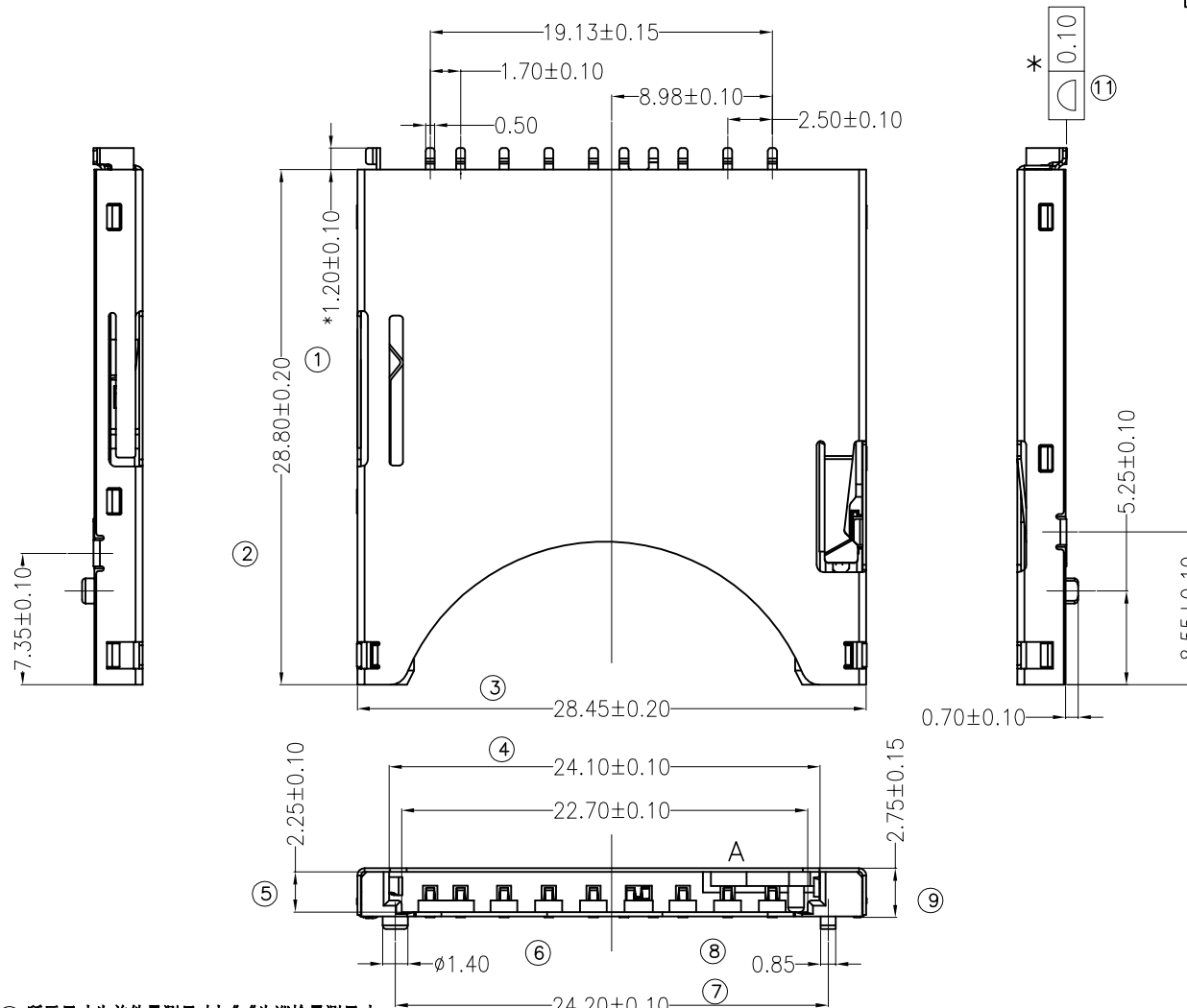
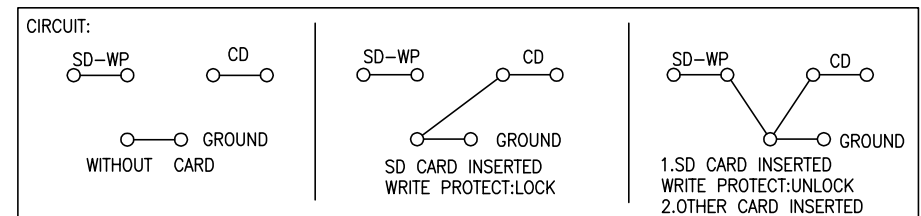


* 所有原料材质, 生产制程, 电镀必须符合ROHS要求



备注:加 ⑩ 所示尺寸为首件量测尺寸加"*"为巡检量测尺寸



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				
3				

Specification

MATERIAL:
 Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy

PLATING:
 Contact: Plated 50u" Ni Overall
 Plated Au Selective Contact Area
 Plated 100u" Sn Over Ni On Solder Area
 Shell: Plated 50u" Ni Overall
 Plated 1u" Au Over Ni On Solder Area

Electrical:
 Current Rating :0.5mA AC/DC max.
 Voltage Rating :125V AC/DC
 Ambient Temperature Range :-20°C~+60°C
 Storage Temperature Range :-40°C~+70°C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100mΩ max.
 Insulation Resistance:1000MΩ min./500VDC
 Mating Cycles:10,000 Insertions

Usable Memory Card:
 SD&MMC Card

Pin No.	SD	MMC
P1	MMC-DAT SD-DAT3	1P
P2	MMC-CMD SD-CMD	2P
P3	MMC-VSS1 SD-VSS1	3P
P4	MMC-VDD SD-VDD	4P
P5	MMC-CLK SD-CLK	5P
P6	MMC-VSS2 SD-VSS2	6P
P7	MMC-DAT SD-DAT0	7P
P8	SD-DAT1	8P
P9	SD-DAT2	9P

深圳市华德共创科技有限公司
 电话: 0755-23304126 传真: 0755-29940187

DIMENSIONS INIT: mm UNLESS OTHERWISE SPECIFIABLE DIMENSION TOLERANCE X.X: ± 0.25 X.XX: ± 0.10 X.XXX: ± 0.05 ANGULAR: ± 1°	PRODUCT NAME : SD PUDH 卡座 (普通款)	DRAWING: COCO	DATE: 2008/12/10
	PRODUCT NO. : K-DYX-001	CHECK: JANY	DATE: 2008/12/10
	DRAWING NO. : NT-001	APPROVED: JEFF	DATE: 2008/12/10
	SCALE: 1:1	DWG ID: P D	REV.: A